imall

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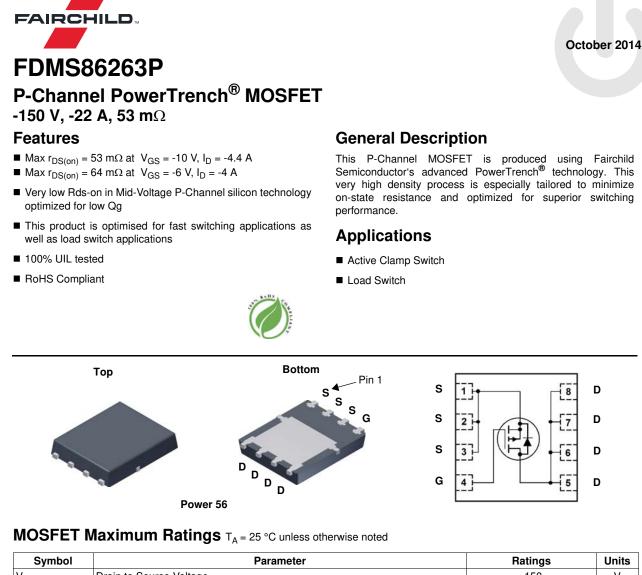
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Symbol	Param	eter		Ratings	Units	
V _{DS}	Drain to Source Voltage			-150	V	
V _{GS}	Gate to Source Voltage			±25	V	
	Drain Current -Continuous	T _C = 25 °C		-22		
I _D	-Continuous	T _A = 25 °C	(Note 1a)	-4.4	Α	
	-Pulsed			-70		
AS	Single Pulse Avalanche Energy		(Note 3)	384	mJ	
۲	Power Dissipation	T _C = 25 °C		104	w	
P _D	Power Dissipation	T _A = 25 °C	(Note 1a)	2.5	vv	
Г _Ј , Т _{STG}	Operating and Storage Junction Tempera	ature Range		-55 to +150	°C	

Thermal Characteristics

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	1.2	°C/W
$R_{ hetaJA}$	Thermal Resistance, Junction to Ambient (Note 1a	50	C/ VV

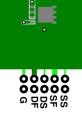
Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS86263P	FDMS86263P	Power 56	13 "	12 mm	3000 units

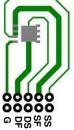
FDMS86263P P-Channel PowerTrench[®] MOSFET

FDMS86263P
P-Channel P
owerTrench
[®] MOSFET

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units	
Off Chara	cteristics						
BV _{DSS}	Drain to Source Breakdown Voltage	$I_D = -250 \ \mu A, \ V_{GS} = 0 \ V$	-150			V	
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$	Breakdown Voltage Temperature Coefficient	$I_D = -250 \ \mu$ A, referenced to 25 °C		-116		mV/°C	
IDSS	Zero Gate Voltage Drain Current	V _{DS} = -120 V, V _{GS} = 0 V			-1	μA	
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 25 \text{ V}, V_{DS} = 0 \text{ V}$			±100	nA	
On Chara	cteristics						
V _{GS(th)}	Gate to Source Threshold Voltage	V _{GS} = V _{DS} , I _D = -250 μA	-2	-2.9	-4	V	
$\Delta V_{GS(th)}$	Gate to Source Threshold Voltage			_			
ΔT_J	Temperature Coefficient	I_D = -250 μ A, referenced to 25 °C		7		mV/°C	
		V _{GS} = -10 V, I _D = -4.4 A		42	53		
r _{DS(on)}	Static Drain to Source On Resistance	$V_{GS} = -6 V, I_D = -4 A$		45	64	mΩ	
()		V_{GS} = -10 V, I _D = -4.4 A,T _J = 125 °C		71	94		
9 FS	Forward Transconductance	$V_{DS} = -10 \text{ V}, \text{ I}_{D} = -4.4 \text{ A}$		19		S	
Dynamic C _{iss}	Characteristics			2935	3905	pF	
C _{oss}	Output Capacitance	$-V_{DS} = -75 V, V_{GS} = 0 V,$		238	315	pF	
C _{rss}	Reverse Transfer Capacitance	f = 1 MHz		11	20	pF	
R _q	Gate Resistance		0.1	2.7	5.4	ρ. Ω	
0							
Switching	Characteristics	11			1	1	
t _{d(on)}	Turn-On Delay Time			17	31	ns	
t _r	Rise Time	$V_{DD} = -75 \text{ V}, \text{ I}_{D} = -4.4 \text{ A},$		10	21	ns	
t _{d(off)}	Turn-Off Delay Time	V_{GS} = -10 V, R_{GEN} = 6 Ω		37	59	ns	
t _f	Fall Time			14	25	ns	
Qg	Total Gate Charge	$V_{GS} = 0 V \text{ to } -10 V$		45	63	nC	
Qg	Total Gate Charge	$V_{GS} = 0 V \text{ to } -6 V V_{DD} = -75 V,$		29	40	nC	
Q _{gs}	Gate to Source Charge	I _D = -4.4 A		11.3		nC	
Q _{gd}	Gate to Drain "Miller" Charge			8.9		nC	
Drain-Sou	urce Diode Characteristics						
V		$V_{GS} = 0 V, I_S = -4.4 A$ (Note 2)		-0.79	-1.3		
V _{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = -2 A$ (Note 2)		-0.75	-1.2	V	
t _{rr}	Reverse Recovery Time	I _F = -4.4 A, di/dt = 100 A/μs		91	146	ns	
Q _{rr}	Reverse Recovery Charge	F = 10000		287	460	nC	



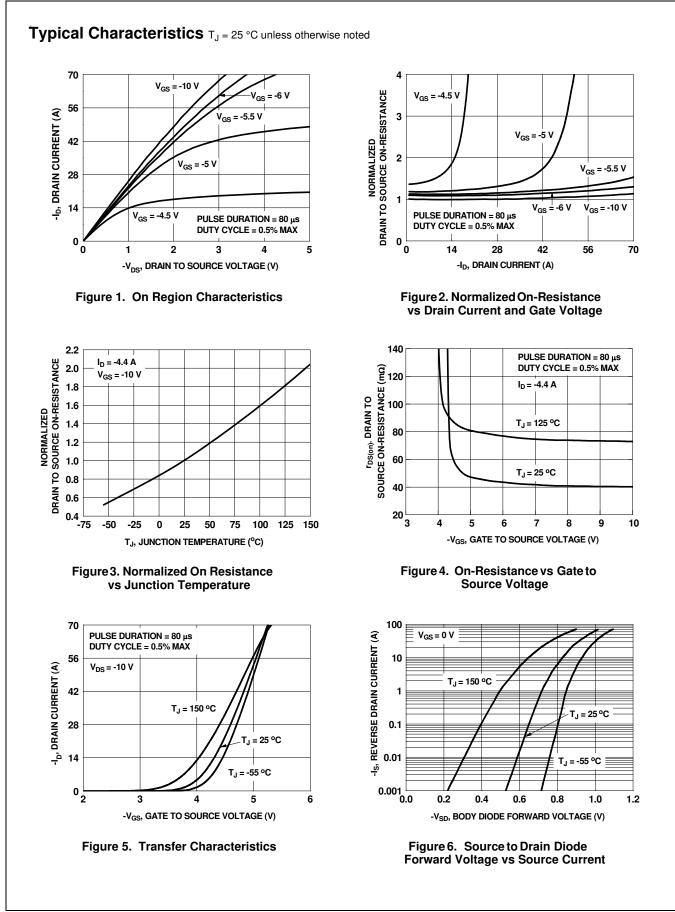
1 in² pad of 2 oz copper

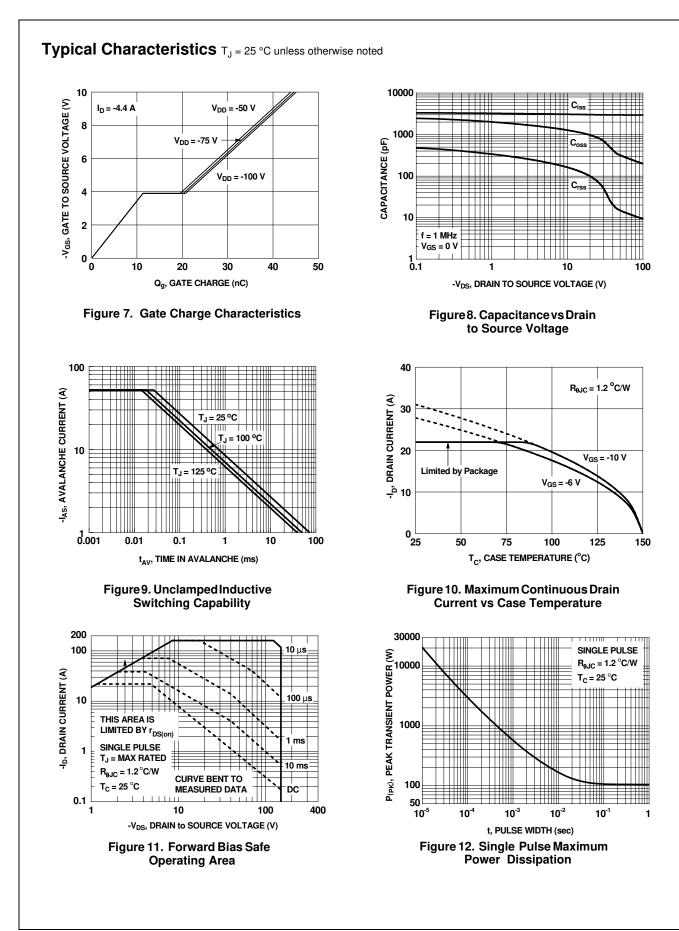


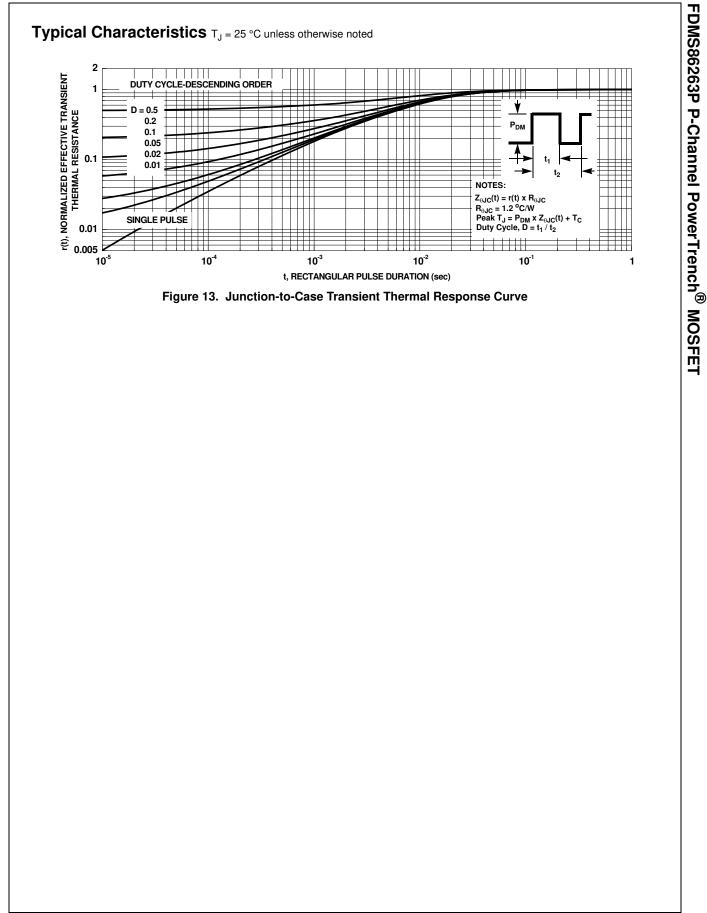
minimum pad of 2 oz copper.

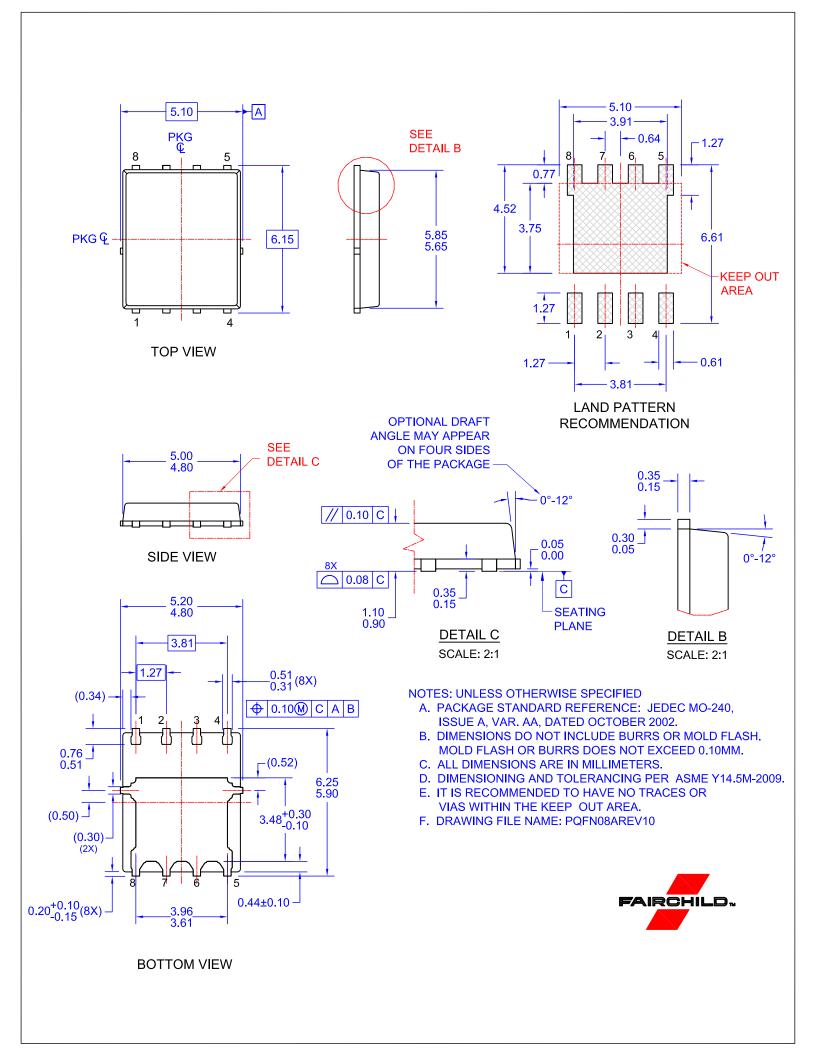
2. Pulse Test: Pulse Width < 300 μ s, Duty cycle < 2.0%. 3. Starting T_J = 25 °C; P-ch: L = 3 mH, I_{AS} = -16 A, V_{DD} = -150 V, V_{GS} = -10 V. 100% test at L = 0.1 mH, I_{AS} = -52 A.

FDMS86263P P-Channel PowerTrench[®] MOSFET









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